SN5404 ... J PACKAGE
SN54LS04, SN54S04 ... J OR W PACKAGE
SN7404, SN74S04...D, N, OR NS PACKAGE
SN74LS04 ... D, DB, N, OR NS PACKAGE

## description/ordering information

These devices contain six independent inverters.
Dependable Texas Instruments Quality and Reliability

These devices contain six independent inverters.

## (TOP VIEW)



SN5404 ... W PACKAGE (TOP VIEW)
 (TOP VIEW)


NC - No internal connection

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

ORDERING INFORMATION

| $\mathrm{T}_{\mathrm{A}}$ | PACKAGE $\dagger$ |  | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
| :---: | :---: | :---: | :---: | :---: |
| $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ | PDIP - N | Tube | SN7404N | SN7404N |
|  |  | Tube | SN74LS04N | SN74LS04N |
|  |  | Tube | SN74S04N | SN74S04N |
|  | SOIC - D | Tube | SN7404D | 7404 |
|  |  | Tape and reel | SN7404DR |  |
|  |  | Tube | SN74LS04D | LS04 |
|  |  | Tape and reel | SN74LS04DR |  |
|  |  | Tube | SN74S04D | S04 |
|  |  | Tape and reel | SN74S04DR |  |
|  | SOP - NS | Tape and reel | SN7404NSR | SN7404 |
|  |  | Tape and reel | SN74LS04NSR | 74LS04 |
|  |  | Tape and reel | SN74S04NSR | 74S04 |
|  | SSOP - DB | Tape and reel | SN74LS04DBR | LS04 |
| $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | CDIP - J | Tube | SN5404J | SN5404J |
|  |  | Tube | SNJ5404J | SNJ5404J |
|  |  | Tube | SN54LS04J | SN54LS04J |
|  |  | Tube | SN54S04J | SN54S04J |
|  |  | Tube | SNJ54LS04J | SNJ54LS04J |
|  |  | Tube | SNJ54S04J | SNJ54S04J |
|  | CFP - W | Tube | SNJ5404W | SNJ5404W |
|  |  | Tube | SNJ54LS04W | SNJ54LS04W |
|  |  | Tube | SNJ54S04W | SNJ54S04W |
|  | LCCC - FK | Tube | SNJ54LS04FK | SNJ54LS04FK |
|  |  | Tube | SNJ54S04FK | SNJ54S04FK |

$\dagger$ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE (each inverter)

| INPUT <br> $\mathbf{A}$ | OUTPUT <br> $\mathbf{Y}$ |
| :---: | :---: |
| $H$ | L |
| L | $H$ |

logic diagram (positive logic)


INSTRUMENTS

## schematics (each gate)





Resistor values shown are nominal.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted) $\dagger$

> Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ (see Note 1) ............................................................................. 7 . 7
> Input voltage, $\mathrm{V}_{\mathrm{I}}$ : ${ }^{\prime} 04$, 'S04 ................................................................................. 5.5 V
> 'LS04 ...................................................................................... 7 V
> Package thermal impedance, $\theta_{\mathrm{JA}}$ (see Note 2): D package . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $86^{\circ} \mathrm{C} / \mathrm{W}$
> DB package ........................................ 96²${ }^{\circ} \mathrm{C} / \mathrm{W}$ N package . .......................................... $80^{\circ} \mathrm{C} / \mathrm{W}$ NS package ........................................ $76^{\circ} \mathrm{C} / \mathrm{W}$
$\dagger$ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. This are stress ratings only, and
functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not
implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTES: 1. Voltage values are with respect to network ground terminal.
2. The package thermal impedance is calculated in accordance with JESD 51-7.
recommended operating conditions (see Note 3)

|  |  | SN5404 |  |  | SN7404 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | NOM | MAX | MIN | NOM | MAX |  |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| $\mathrm{V}_{\text {IH }}$ | High-level input voltage | 2 |  |  | 2 |  |  | V |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage |  |  | 0.8 |  |  | 0.8 | V |
| ${ }^{\text {IOH}}$ | High-level output current |  |  | -0.4 |  |  | -0.4 | mA |
| ${ }^{\text {IOL }}$ | Low-level output current |  |  | 16 |  |  | 16 | mA |
| $\mathrm{T}_{\text {A }}$ | Operating free-air temperature | -55 |  | 125 | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

NOTE 3: All unused inputs of the device must be held at $\mathrm{V}_{\mathrm{CC}}$ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS $\ddagger$ |  |  | SN5404 |  |  | SN7404 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP§ | MAX | MIN | TYP§ | MAX |  |
| $\mathrm{V}_{\mathrm{IK}}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}$, | $\mathrm{I}=-12 \mathrm{~mA}$ |  |  |  | -1.5 |  |  | -1.5 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}$, | $\mathrm{V}_{\mathrm{IL}}=0.8 \mathrm{~V}$, | $\mathrm{IOH}=-0.4 \mathrm{~mA}$ | 2.4 | 3.4 |  | 2.4 | 3.4 |  | V |
| $\mathrm{V}_{\text {OL }}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}$, | $\mathrm{V}_{\mathrm{IH}}=2 \mathrm{~V}$, | $\mathrm{IOL}=16 \mathrm{~mA}$ |  | 0.2 | 0.4 |  | 0.2 | 0.4 | V |
| I | $V_{C C}=$ MAX, | $\mathrm{V}_{\mathrm{I}}=5.5 \mathrm{~V}$ |  |  |  | 1 |  |  | 1 | mA |
| IIH | $V_{C C}=$ MAX, | $\mathrm{V}_{\mathrm{I}}=2.4 \mathrm{~V}$ |  |  |  | 40 |  |  | 40 | $\mu \mathrm{A}$ |
| IIL | $V_{C C}=$ MAX, | $\mathrm{V}_{1}=0.4 \mathrm{~V}$ |  |  |  | -1.6 |  |  | -1.6 | mA |
| Ios ${ }^{1}$ | $V_{C C}=$ MAX |  |  | -20 |  | -55 | -18 |  | -55 | mA |
| ICCH | $V_{C C}=$ MAX, | $\mathrm{V}_{1}=0 \mathrm{~V}$ |  |  | 6 | 12 |  | 6 | 12 | mA |
| ICCL | $V_{C C}=\mathrm{MAX}$, | $\mathrm{V}_{\mathrm{I}}=4.5 \mathrm{~V}$ |  |  | 18 | 33 |  | 18 | 33 | mA |

[^0]
## switching characteristics, $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS |  | SN5404 SN7404 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | MIN | TYP | MAX |  |
| tPLH | A | Y | $\mathrm{R}_{\mathrm{L}}=400 \Omega$, | $C_{L}=15 \mathrm{pF}$ |  | 12 | 22 | ns |
| tPHL |  |  |  |  |  | 8 | 15 |  |

## recommended operating conditions (see Note 3)

|  |  | SN54LS04 |  |  | SN74LS04 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | NOM | MAX | MIN | NOM | MAX |  |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage | 2 |  |  | 2 |  |  | V |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage |  |  | 0.7 |  |  | 0.8 | V |
| ${ }^{\text {I OH}}$ | High-level output current |  |  | -0.4 |  |  | -0.4 | mA |
| IOL | Low-level output current |  |  | 4 |  |  | 8 | mA |
| $\mathrm{T}_{\text {A }}$ | Operating free-air temperature | -55 |  | 125 | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

NOTE 3: All unused inputs of the device must be held at $\mathrm{V}_{\mathrm{CC}}$ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS $\dagger$ |  |  | SN54LS04 |  |  | SN74LS04 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP¥ | MAX | MIN | TYP $\ddagger$ | MAX |  |
| $\mathrm{V}_{\mathrm{IK}}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}$, | $\mathrm{I}=-18 \mathrm{~mA}$ |  |  |  | -1.5 |  |  | -1.5 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}$, | $\mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}$, | $\mathrm{I} \mathrm{OH}=-0.4 \mathrm{~mA}$ | 2.5 | 3.4 |  | 2.7 | 3.4 |  | V |
| VOL | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}$, | $\mathrm{V}_{\mathrm{IH}}=2 \mathrm{~V}$ | $\mathrm{IOL}=4 \mathrm{~mA}$ |  | 0.25 | 0.4 |  |  | 0.4 | V |
|  |  |  | $\mathrm{IOL}=8 \mathrm{~mA}$ |  |  |  |  | 0.25 | 0.5 |  |
| 1 | $V_{C C}=$ MAX, | $\mathrm{V}_{\mathrm{I}}=7 \mathrm{~V}$ |  |  |  | 0.1 |  |  | 0.1 | mA |
| IIH | $V_{C C}=$ MAX, | $\mathrm{V}_{1}=2.7 \mathrm{~V}$ |  |  |  | 20 |  |  | 20 | $\mu \mathrm{A}$ |
| IIL | $V_{C C}=$ MAX, | $\mathrm{V}_{1}=0.4 \mathrm{~V}$ |  |  |  | -0.4 |  |  | -0.4 | mA |
| Ios§ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}$ |  |  | -20 |  | -100 | -20 |  | -100 | mA |
| ICCH | $V_{C C}=$ MAX, | $\mathrm{V}_{\mathrm{I}}=0 \mathrm{~V}$ |  |  | 1.2 | 2.4 |  | 1.2 | 2.4 | mA |
| ${ }^{\text {ICCL }}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}$, | $\mathrm{V}_{\mathrm{l}}=4.5 \mathrm{~V}$ |  |  | 3.6 | 6.6 |  | 3.6 | 6.6 | mA |

$\dagger$ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
$\ddagger$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

## switching characteristics, $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathbf{2 5}^{\circ} \mathrm{C}$ (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS |  | $\begin{aligned} & \hline \text { SN54LS04 } \\ & \text { SN74LS04 } \end{aligned}$ |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | MIN | TYP | MAX |  |
| tPLH | A | Y | $R_{L}=2 \mathrm{k} \Omega$, | $C_{L}=15 \mathrm{pF}$ |  | 9 | 15 | ns |
| tPHL |  |  |  |  |  | 10 | 15 |  |

recommended operating conditions (see Note 3)

|  |  | SN54S04 |  |  | SN74S04 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | NOM | MAX | MIN | NOM | MAX |  |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage | 2 |  |  | 2 |  |  | V |
| VIL | Low-level input voltage |  |  | 0.8 |  |  | 0.8 | V |
| IOH | High-level output current |  |  | -1 |  |  | -1 | mA |
| IOL | Low-level output current |  |  | 20 |  |  | 20 | mA |
| $\mathrm{T}_{\text {A }}$ | Operating free-air temperature | -55 |  | 125 | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

NOTE 3: All unused inputs of the device must be held at $\mathrm{V}_{\mathrm{CC}}$ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS $\dagger$ |  |  | SN54S04 |  |  | SN74S04 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYPキ | MAX | MIN | TYP $\ddagger$ | MAX |  |
| $\mathrm{V}_{\mathrm{IK}}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}$, | $\boldsymbol{I}=-18 \mathrm{~mA}$ |  | -1.2 |  |  | -1.2 |  |  | V |
| $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}$, | $\mathrm{V}_{\mathrm{IL}}=0.8 \mathrm{~V}$, | $\mathrm{IOH}=-1 \mathrm{~mA}$ | 2.5 | 3.4 |  | 2.7 | 3.4 |  | V |
| VOL | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}$, | $\mathrm{V}_{\mathrm{IH}}=2 \mathrm{~V}$, | $\mathrm{IOL}=20 \mathrm{~mA}$ | 0.5 |  |  | 0.5 |  |  | V |
| I | $V_{C C}=$ MAX, | $\mathrm{V}_{\mathrm{I}}=5.5 \mathrm{~V}$ |  | 1 |  |  |  |  | 1 | mA |
| IIH | $V_{C C}=M A X$, | $\mathrm{V}_{1}=2.7 \mathrm{~V}$ |  | 50 |  |  |  |  | 50 | $\mu \mathrm{A}$ |
| ILL | $V_{C C}=$ MAX, | $\mathrm{V}_{1}=0.5 \mathrm{~V}$ |  | -2 |  |  |  |  | -2 | mA |
| Ios§ | $V_{C C}=$ MAX |  |  | -40 |  | -100 | -40 |  | -100 | mA |
| ICCH | $V_{C C}=$ MAX, | $\mathrm{V}_{\mathrm{I}}=0 \mathrm{~V}$ |  |  | 15 | 24 |  | 15 | 24 | mA |
| ICCL | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}$, | $\mathrm{V}_{\mathrm{I}}=4.5 \mathrm{~V}$ |  |  | 30 | 54 |  | 30 | 54 | mA |

$\dagger$ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
$\ddagger$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.
switching characteristics, $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS |  | SN54S04 <br> SN74S04 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | MIN | TYP | MAX |  |
| tPLH | A | Y | $\mathrm{R}_{\mathrm{L}}=280 \Omega$, | $C_{L}=15 \mathrm{pF}$ |  | 3 | 4.5 | ns |
| tPHL |  |  |  |  |  | 3 | 5 |  |
| tPLH | A | Y | $R_{L}=280 \Omega$, | $C_{L}=50 \mathrm{pF}$ |  | 4.5 |  | ns |
| tPHL |  |  |  |  |  | 5 |  |  |

# PARAMETER MEASUREMENT INFORMATION <br> SERIES 54/74 AND 54S/74S DEVICES 



NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. All diodes are 1 N3064 or equivalent.
C. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
D. S1 and S2 are closed for tPLH, tPHL, tPHZ, and tPLZ; S1 is open and S2 is closed for tPZH; S1 is closed and S2 is open for tPZL•
E. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 1 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}} \approx 50 \Omega$; $\mathrm{t}_{\mathrm{r}}$ and $\mathrm{t}_{\mathrm{f}} \leq 7 \mathrm{~ns}$ for Series $54 / 74$ devices and $\mathrm{t}_{\mathrm{r}}$ and $\mathrm{t}_{\mathrm{f}} \leq 2.5 \mathrm{~ns}$ for Series 54S/74S devices.
F. The outputs are measured one at a time, with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

## PARAMETER MEASUREMENT INFORMATION SERIES 54LS/74LS DEVICES



FOR 2-STATE TOTEM-POLE OUTPUTS
FOR OPEN-COLLECTOR OUTPUTS


Voltage waveforms
SETUP AND HOLD TIMES


VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

NOTES: A. $\mathrm{C}_{\mathrm{L}}$ includes probe and jig capacitance.
B. All diodes are 1 N3064 or equivalent.
C. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
D. S1 and S2 are closed for tPLH, tPHL, tPHZ, and tPLZ; S1 is open and S2 is closed for tPZH; S1 is closed and S2 is open for tPZL.
E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
F. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 1 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}} \approx 50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 1.5 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 2.6 \mathrm{~ns}$.
G. The outputs are measured one at a time, with one input transition per measurement.

Figure 2. Load Circuits and Voltage Waveforms

## PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package Type | Package Drawing |  | Package Qty | Eco Plan ${ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| JM38510/00105BCA | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N / A for Pkg Type |
| JM38510/00105BDA | ACTIVE | CFP | W | 14 | 1 | TBD | A42 | N/ A for Pkg Type |
| JM38510/07003BCA | ACTIVE | CDIP | $J$ | 14 | 1 | TBD | A42 | N/ A for Pkg Type |
| JM38510/30003B2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N/ A for Pkg Type |
| JM38510/30003BCA | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N/ A for Pkg Type |
| JM38510/30003BDA | ACTIVE | CFP | W | 14 | 1 | TBD | A42 | N/ A for Pkg Type |
| JM38510/30003SCA | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N/ A for Pkg Type |
| JM38510/30003SDA | ACTIVE | CFP | W | 14 | 1 | TBD | A42 | N / A for Pkg Type |
| SN5404J | ACTIVE | CDIP | $J$ | 14 | 1 | TBD | A42 | N / A for Pkg Type |
| SN54LS04J | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N/ A for Pkg Type |
| SN54S04J | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N / A for Pkg Type |
| SN7404D | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br})$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN7404DE4 | ACTIVE | SOIC | D | 14 | 50 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN7404DG4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM |
| SN7404DR | ACTIVE | SOIC | D | 14 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN7404DRE4 | ACTIVE | SOIC | D | 14 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN7404DRG4 | ACTIVE | SOIC | D | 14 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN7404N | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| SN7404N3 | OBSOLETE | PDIP | N | 14 |  | TBD | Call TI | Call TI |
| SN7404NE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N/A for Pkg Type |
| SN7404NSR | ACTIVE | SO | NS | 14 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN7404NSRE4 | ACTIVE | SO | NS | 14 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN7404NSRG4 | ACTIVE | SO | NS | 14 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS04D | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS04DE4 | ACTIVE | SOIC | D | 14 | 50 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS04DG4 | ACTIVE | SOIC | D | 14 | 50 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS04DR | ACTIVE | SOIC | D | 14 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS04DRE4 | ACTIVE | SOIC | D | 14 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS04DRG4 | ACTIVE | SOIC | D | 14 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS04J | OBSOLETE | CDIP | J | 14 |  | TBD | Call TI | Call TI |


| Orderable Device | Status ${ }^{(1)}$ | Package Type | Package Drawing |  | Package Qty | Eco Plan ${ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74LS04N | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| SN74LS04N3 | OBSOLETE | PDIP | N | 14 |  | TBD | Call TI | Call TI |
| SN74LS04NE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N/A for Pkg Type |
| SN74LS04NSR | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br})$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS04NSRG4 | ACTIVE | SO | NS | 14 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74S04D | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74S04DE4 | ACTIVE | SOIC | D | 14 | 50 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74S04DG4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS \& no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74S04DR | ACTIVE | SOIC | D | 14 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74S04DRE4 | ACTIVE | SOIC | D | 14 | 2500 | $\begin{gathered} \hline \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74S04DRG4 | ACTIVE | SOIC | D | 14 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74S04N | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| SN74S04N3 | OBSOLETE | PDIP | N | 14 |  | TBD | Call TI | Call TI |
| SN74S04NE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N/A for Pkg Type |
| SN74S04NSR | ACTIVE | SO | NS | 14 | 2000 | $\begin{gathered} \hline \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74S04NSRE4 | ACTIVE | SO | NS | 14 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74S04NSRG4 | ACTIVE | SO | NS | 14 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SNJ5404J | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N/ A for Pkg Type |
| SNJ5404W | ACTIVE | CFP | W | 14 | 1 | TBD | A42 | N/ A for Pkg Type |
| SNJ54LS04FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N/ A for Pkg Type |
| SNJ54LS04J | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N / A for Pkg Type |
| SNJ54LS04W | ACTIVE | CFP | W | 14 | 1 | TBD | A42 | N/ A for Pkg Type |
| SNJ54S04FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N/ A for Pkg Type |
| SNJ54S04J | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N/A for Pkg Type |
| SNJ54S04W | ACTIVE | CFP | W | 14 | 1 | TBD | A42 | N/ A for Pkg Type |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but Tl does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[^1]TBD: The Pb-Free/Green conversion plan has not been defined.
Pb -Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb -Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS \& no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

*All dimensions are nominal

| Device | Package <br> Type | Package <br> Drawing | Pins | SPQ | Reel <br> Diameter <br> $(\mathbf{m m})$ | Reel <br> Width <br> W1 $(\mathbf{m m})$ | A0 (mm) | B0 (mm) | K0 (mm) | P1 <br> $(\mathbf{m m})$ | W <br> $(\mathbf{m m})$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN7404DR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN7404NSR | SO | NS | 14 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74LS04DR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74LS04NSR | SO | NS | 14 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74S04DR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74S04NSR | SO | NS | 14 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN7404DR | SOIC | D | 14 | 2500 | 346.0 | 346.0 | 33.0 |
| SN7404NSR | SO | NS | 14 | 2000 | 346.0 | 346.0 | 33.0 |
| SN74LS04DR | SOIC | D | 14 | 2500 | 346.0 | 346.0 | 33.0 |
| SN74LS04NSR | SO | NS | 14 | 2000 | 346.0 | 346.0 | 33.0 |
| SN74S04DR | SOIC | D | 14 | 2500 | 346.0 | 346.0 | 33.0 |
| SN74S04NSR | SO | NS | 14 | 2000 | 346.0 | 346.0 | 33.0 |



| DIM PINS ** | 14 | 16 | 18 | 20 |
| :---: | :---: | :---: | :---: | :---: |
| A | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC |
| B MAX | 0.785 <br> $(19,94)$ | .840 <br> $(21,34)$ | 0.960 <br> $(24,38)$ | 1.060 <br> $(26,92)$ |
| B MIN | - | - | - | - |
| C MAX | 0.300 <br> $(7,62)$ | 0.300 <br> $(7,62)$ | 0.310 <br> $(7,87)$ | 0.300 <br> $(7,62)$ |
| C MIN | 0.245 <br> $(6,22)$ | 0.245 <br> $(6,22)$ | 0.220 <br> $(5,59)$ | 0.245 <br> $(6,22)$ |



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## W (R-GDFP-F14)



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

FK (S-CQCC-N**)
LEADLESS CERAMIC CHIP CARRIER 28 TERMINAL SHOWN


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. Falls within JEDEC MS-004

N (R-PDIP-T**)
PLASTIC DUAL-IN-LINE PACKAGE
16 PINS SHOWN


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C) Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

D The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G14)
PLASTIC SMALL OUTLINE


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.

C Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed $0.006(0,15)$ each side.
D Body width does not include interlead flash. Interlead flash shall not exceed $0.017(0,43)$ each side.
E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC-7351 is recommended for alternate designs.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

NS (R-PDSO-G**)
14-PINS SHOWN


| DIM PINS ** | 14 | 16 | 20 | 24 |
| :---: | :---: | :---: | :---: | :---: |
| A MAX | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN | 9,90 | 9,90 | 12,30 | 14,70 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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[^0]:    $\ddagger$ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
    § All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
    I Not more than one output should be shorted at a time.

[^1]:    ${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

